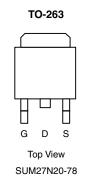




# N-Channel 200 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A)	
200	0.078 at V <sub>GS</sub> = 10 V	27	
	0.083 at V <sub>GS</sub> = 6 V	26	



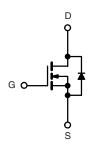
Ordering Information: SUM27N20-78-E3 (Lead (Pb)-free)

### **FEATURES**

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- PWM Optimized for Fast Switching
- Compliant to RoHS Directive 2002/95/EC

### **APPLICATIONS**

- · Isolated DC/DC Converters
  - Primary-Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	<b>GS</b> ( $T_C = 25  ^{\circ}C$ , unless o	otherwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V <sub>DS</sub>	200	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20	V		
Continuous Drain Current (T <sub>1</sub> = 175 °C)	T <sub>C</sub> = 25 °C	1-	27		
Continuous Diam Current (1j = 173 C)	T <sub>C</sub> = 125 °C	I <sub>D</sub>	15.5		
Pulsed Drain Current	I <sub>DM</sub>	60	A		
Avalanche Current	I <sub>AR</sub>	18			
Repetitive Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AR</sub>	16.2	mJ	
	T <sub>C</sub> = 25 °C	В	150 <sup>b</sup>	W	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 25 °C <sup>c</sup>	P <sub>D</sub>	3.75		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Limit	Unit			
Junction-to-Ambient	PCB Mount (TO-263) <sup>c</sup>	R <sub>thJA</sub>	40	°C/W		
Junction-to-Case (Drain)		R <sub>thJC</sub>	1	C/VV		

### Notes:

- a. Duty cycle  $\leq$  1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR-4 material).

# Vishay Siliconix



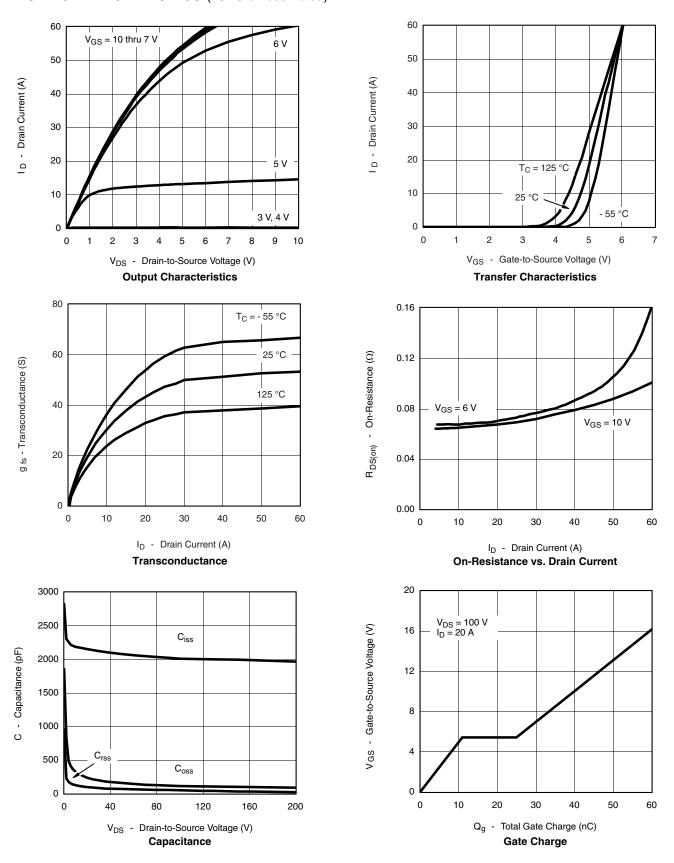
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min .	Тур.	Max.	Unit
Static	•			•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	200			V
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 160 V, V <sub>GS</sub> = 0 V			1	μΑ
	I <sub>DSS</sub>	V <sub>DS</sub> = 160 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	
		V <sub>DS</sub> = 160 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 15 \text{ V}, V_{GS} = 10 \text{ V}$	60			Α
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A		0.064	0.078	
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C			0.160	Ω
	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C			0.205	
Drain-Source on State Resistance		V <sub>GS</sub> = 6 V, I <sub>D</sub> = 15 A		0.068	0.083	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	15			S
Dynamic <sup>b</sup>	•				!	
Input Capacitance	C <sub>iss</sub>			2150		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		215		
Reverse Transfer Capacitance	C <sub>rss</sub>			90		
Total Gate Charge <sup>c</sup>	$Q_{g}$			40	60	nC
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		11		
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			14		
Gate Resistance	$R_{G}$			2		Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			15	25	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 100 \text{ V}, R_L = 5 \Omega$		35	55	ns
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 20 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		40	60	
Fall Time <sup>c</sup>	t <sub>f</sub>			30	45	
Source-Drain Diode Ratings and Cha	aracteristics (	T <sub>C</sub> = 25 °C) <sup>b</sup>	L		l	
Continuous Current	Is				27	
Pulsed Current	I <sub>SM</sub>				60	Α
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 20 A, V <sub>GS</sub> = 0 V		1	1.5	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 50 A, dl/dt = 100 A/μs		115	170	ns
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>			7.5	12	Α
Reverse Recovery Charge	Q <sub>rr</sub>			0.43	1.02	μC

- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

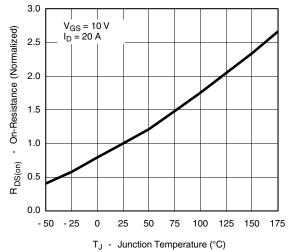


### TYPICAL CHARACTERISTICS (25 °C unless noted)

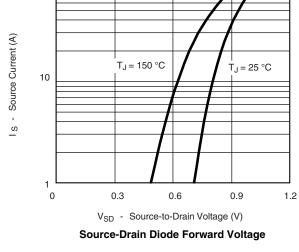


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### TYPICAL CHARACTERISTICS (25 °C unless noted)

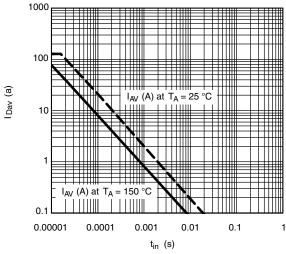


On-Resistance vs. Junction Temperature

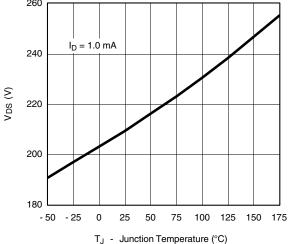


100

260



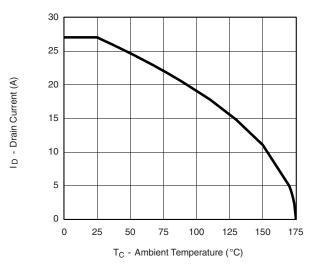
Avalanche Current vs. Time



**Drain Source Breakdown** vs. Junction Temperature

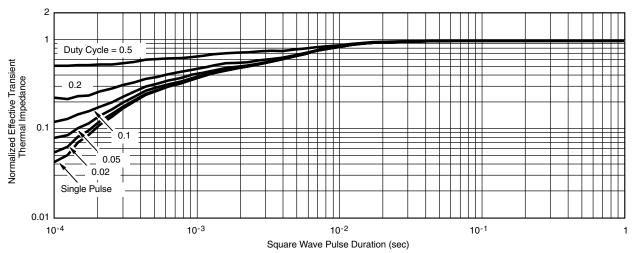


### THERMAL RATINGS



100 10 μs ID - Drain Current (A) 10 10 ms ------100 ms, DC T<sub>C</sub> = 25 °C Single Pulse 0.1 0.1 10 100 1000  $V_{DS}$  - Drain-to-Source Voltage (V) \*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified Safe Operating Area

**Maximum Avalanche and Drain Current** vs. Case Temperature



Normalized Thermal Transient Impedance, Junction-to-Case

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Revision: 13-Jun-16 1 Document Number: 91000